N1155

GENERAL DESCRIPTION

The N1155 is a synchronous-buck switch-mode controller designed for use in single ended power supply applications where efficiency is the primary concern. The controller is a hysteretic type, with a user selectable hysteresis. The N1155 is ideal for implementing DC/DC converters needed to power advanced microprocessors such as Pentium[®] III and Athlon[®], in both single and multiple processor configurations. Inhibit, under-voltage lockout and soft-start functions are included for controlled power-up.

N1155 features include an integrated 5 bit D/A converter, temperature compensated voltage reference, current limit comparator, over-current protection, and an adaptive deadtime circuit to prevent shoot-through of the power MOSFET during switching transistors. Power good signaling, logic compatible shutdown, and over-voltage protection are also provided. The integrated D/A converter provides programmability of output voltage from

1.1V to 1.85V in 25mV increments.

The N1155 high side driver can be configured as either a ground-referenced or as a floating bootstrap driver. The high and low side MOSFET drivers have a peak current rating of 2 amps.

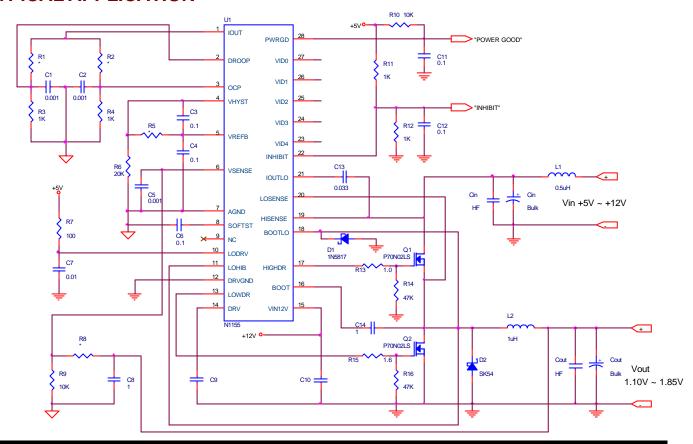
FEATURES

- Programmable hysteresis
- 5 bit DAC Programmable output(1.1V-1.85V)
- On-chip power good and OVP functions
- Designed to meet latest Intel specifications
- Up to 95% efficiency
- ±1% tolerance over temperature

APPLICATIONS

- Sever Systems and Workstations
- Pentium ® III Core Supplies
- AMD Athlon ® Core Supplies
- Multiple Microprocessor Supplies
- Voltage Regulator Modules

TYPICAL APPLICATION



5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

ABSOLUTE MAXIMUM RATINGS

• VIN12 V	- 0.3V to 14V	IOUTLO to AGND	-0.3V to 14V
 BOOT to DRVGND 	-0.3V to 20V	HISENSE to AGND	-0.3V to 14V
 BOOT to BOOTLO 	-0.3V to 15V	VSENSE to AGND	-0.3V to 5V
 BOOTLO to DRVGND 	-0.5V to 18V	 Continuous Power Dissipation, T_A=25°C 	1.2W
 VIDS, INHIB, LODRV, OCP, DROOP 	-0.5V to 7.3V	 Continuous Power Dissipation, Tc=25°C 	6.25W
 AGND to DRVGND 	± 05∨	 Operating Junction Temperature Range, T_J 	0 to 125 °C
● LOHIB to AGND	-0.3V to 14V	 Lead Temperature, T_{LEAD} (Soldering, 10 Seconds) 	300 °C
LOSENSE to AGND	-0.3V to 14V	 Storage Temperature Range, T_{STG} 	-65 to 150 °C

DC ELECTRICAL SPECIFICATIONS

<Unless specified: VIN =12V, 0<T_J < 125°C>

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	V _{CC}	11.4	12	13	V
Supply Current (Quiescent)	INH=5V, VID not 11111, VIN above UVLO threshold during start-up, fsw=200KHz, BOOTLO=0V, CDH=CDL=50pF		15		mA
High Side Driver Supply Current (Quiescent)	INH=0V or VID=11111 or Vin below UVLO threshold during start-up, BOOT=13V, BOOTLO=0V			10	uA
	INH=5V, VID not 11111, VIN above UVLO threshold during start-up, fsw=200KHz, BOOT=13V, BOOTLO=0V, CDH=50pF		5		mA
Reference/Voltage Identification	•	•	•	•	
Reference voltage Accuracy	11.4V <vin12v<12.6v, (see="" full="" output="" over="" range="" table)<="" td="" vid="" voltage=""><td>-1</td><td></td><td>1</td><td>%</td></vin12v<12.6v,>	-1		1	%
VID0-VID4 High Threshold Voltage		2.25			V
VID0-VID4 Low Threshold Voltage				1	V

N1155

5 Bit Programmable Synchronous DC/DC N1155 Hysteretic Controller with VRM 9.0 VID Range

Power Good					
Undervoltage Threshold		90		95	%
Output Saturation Voltage	lo=5mA		0.5		V
Hysteresis			10		mV
Over Voltage Protection			•	•	
OVP Trip Point		2.08	2.15	2.22	V
Soft Start					
Charge Current	Vss=0.5V, resistance from V REFB pin to AGND=20K , VREFB=1.3V Note: ICHG=(NREFB/5)	10.4	13	15.6	uA
Discharge Current	Vss=1V		1		mΑ
Inhibit Comparator					
Start Threshold		1	2	2.4	V
VIN12V UVLO					
Start Threshold		9.25	10.25	11.25	V
Hysteresis		1.8	2	2.2	V
Hysteretic Comparator					
Input Offset Voltage	Vdrooppin grounded			5	mV
Input Bias Current				1	uA
Hysteresis Accuracy				7	mV
Hysteresis Setting				60	mV
Droop Compensation					
Initial Accuracy	Vdroop=50mV			5	mV
Overcurrent Protection					
OCP Trip Point		0.09	0.1	0.11	V
Input Bias Current				100	nA
High-Side VDS Sensing					
Gain			2		V/V
Initial Accuracy	VHISENSE=12V, VIOUTLO=11.9V			6	mV
IOUT Source Current	VIOUT=0.5V, VHISENSE=12V, VIOUTLO=11.5V	500			uA
IOUT Sink Current	VIOUT=0.05V, VHISENSE=12V, VIOUTLO=12V	40	50		uA
VIOUT Voltage Swing	VHISENSE=11V, RIOUT=10K	0		3.75	V
	VHISENSE=4.5V, RIOUT=10K	0		2.0	V
	VHISENSE=3V, RIOUT=10K	0		1.0	V
LOSENSE High Level Input Voltage	VHISENSE=4.5V (Note 1)	2.85			V
LOSENSE Low Level Input Voltage	VHISENSE=4.5V (Note 1)			1.8	V

APR-29-2002

5 Bit Programmable Synchronous DC/DC N1155 Hysteretic Controller with VRM 9.0 VID Range

Sample/Hold Posistance	(Note 1)	50	65	80	
Sample/Hold Resistance	(Note 1)	50	65	00	
Buffered Reference	T	1	1 -		
VREFB Load Regulation	10uA <lrefb<500ua< td=""><td></td><td>2</td><td></td><td>mV</td></lrefb<500ua<>		2		mV
Deadtime Circuit					
LOHIB High Level Input Voltage	(Note 1)	2			V
LOHIB Low Level Input Voltage	(Note 1)			1	V
LOWDR High Level Input Voltage	(Note 1)	2			V
LOWDR Low Level Voltage	(Note 1)			1	V
Drive Regulator					
DRV Voltage	11.4 <vin12v<12.6v, IDRV=50mA</vin12v<12.6v, 	8		10	V
Load Regulation	1mA <lorv<50ma< td=""><td></td><td>100</td><td></td><td>mV</td></lorv<50ma<>		100		mV
Short Circuit Current		100			mA
High-Side Output Driver (Note 1)					
Peak Output Current	Duty cycle<2%, tpw<100us, TJ=125°C, VBOOT-VBOOTLO=6.5V, VHIGHDR=1.5V(source) or VHIGHDR=5V(sink)	2			А
Equivalent Output Resistance	TJ=125°C, VBOOT-VBOOTLO=6.5V, VHIGHDR=6V (Source)			45	
	TJ=125°C, VBOOT-VBOOTLO=6.5V, VHIGHDR=0.5V (Sink)			5	
Low-Side Output Driver (Note 1)					
Peak Output Current	Duty cycle<2%, tpw<100us, TJ=125°C, VDRV-VBOOTLO=6.5V, VLOWDR=1.5V(source) or VLOWDR=5V(sink)	2			A
Equivalent Output Resistance	TJ=125°C, V _{DRV} =6.5V, V _{LOWDR} =6V (Source)			45	
	TJ=125°C, VDRV =6.5V, VLOWDR=0.5V (Sink)			5	

AC ELECTRICAL SPECIFICAT IONS (Note 1)

Hysteretic Comparators							
Propagation Delay Time from VSENSE to HIGHDR or LOWDR (excluding deadtime)	10mV overdrive, 1.3V VREF 1.8V	150	250	ns			
Output Drivers							

4

APR-29-2002

5 Bit Programmable Synchronous DC/DC N1155 Hysteretic Controller with VRM 9.0 VID Range

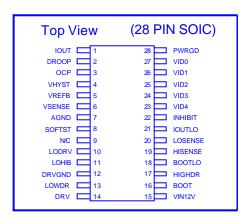
HIGHDR rise/fall time	CI=9nF,VBOOT=6.5V, VBOOTLO=grounded, TJ=125°C			60	ns
LOWDR rise/fall time	CI=9nF,VDRV=6.5V, TJ=125°C			60	ns
Overcurrent Protection					
Comparator Propagation Delay Time				1	us
Deglitch Time (Includes comparator propagation delay time)		2		5	us
Overvoltage Protection					
Comparator Propagation Delay Time			1		us
Deglitch Time (Includes comparator propagation delay time)		1		3	US
High-Side Vds Sensing					
Response Time	VHISENSE=12V, VIOUTLO pulsed from 12V to 11.9V, 100ns rise and fall times			2	US
	VHISENSE=4.5V, VIOUTLO pulsed from 4.5V to 4.4V, 100ns rise and fall times			3	US
	VHISENSE=3V, VIOUTLO pulsed from 3V to 2.9V, 100ns rise and fall times			3	US
Short Circuit Protection Rising Edge Delay	LOSENSE grounded	300		500	ns
Sample/Hold Switch turn-on/turn-off Delay	3V <vhisense<11v, VLOSENSE=VHISENSE</vhisense<11v, 	30		100	ns
Power Good					
Comparator Propagation Delay			1		us
Softstart					
Comparator Propagation Delay	Overdrive=10mV		560	900	ns
Deadtime					
Driver Nonoverlap Time	CLOWDR=9nF, 10% threshold on LOWDR	30		100	ns
LODRV					
Propagation Delay				400	ns

Notes:

- (1) Guaranteed, but not tested.
- (2) This device is ESD sensitive. Use of standard ESD handling precautions is required.

5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

PIN CONFIGURATIONS



N1155

5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

N1155

PIN DEFINITIONS

Pin#	Pin Name	Pin Function Description
1	IOUT	Current Out. The output voltage on this pin is proportional to the load current as measured across the high side MOSFET, and is approximately equal to 2 X RDS(ON) X LOAD.
2	DROOP	Droop Voltage. This pin is used to set the amount of voltage set-point droop as a function of load current. The voltage is set by a resistor divider between IOUT and AGND.
3	OCP	Over Current Protection. This pin is used to set the trip point for over current protection by a resistor divider between IOUT and AGND.
4	VHYST	Hystersis Set Pin. This pin is used to set the amount for hystersis required by a resistor divider between VREFB and AGND.
5	VREFB	Buffered Reference Voltage (from VID circuitry).
6	VSENSE	Output Voltage Sense.
7	AGND	Small Signal Analog and Digital Ground.
8	SOFTST	Soft Start. Connecting a capacitor from this pin to AGND sets this pin to AGND sets the time delay.
9	NC	Not Connected.
10	LODRV	Low Drive Control. Connecting this pin to +5V enables normal operation. When LOHIB is grounded, this pin can be used to control LOWDR.
11	LOHIB	Low Side Inhibit. This pin is used to eliminate shoot-thru current.
12	DRVGND	Power Ground. Insure output capacitor ground is connected to this pin.
13	LOWDR	Low Side Driver Output. Connect to gate of low side MOSFET.
14	DRV	Drive Regulator for the MOSFET Drivers.
15	VIN12V	12C Supply. Connect to 12V power rail.
16	BOOT	Bootstrap. This pin is used to generate a floating drive for the high side FET driver.
17	HIGHDR	High Side Driver Output. Connect to gate of high side MOSFET.
18	BOOTLO	Bootstrap Low. In desktop application, this pin connect to DRVGND.
19	HISENSE	High Current Sense. Connect to the drain of the high side FET, or the input side of a current sense resistor between the input and high side FET.
20	LOSENSE	Low Current Sense. Connect to the source of the high side FET, or the FET side of a current sense resistor between the input and high side FET.
21	IOTLO	This is the sampling capacitors bottom leg. Voltage on this pin is voltage on the LOSENSE pin when the high side FET is on.
22	INHIBIT	Inhibit. If this pin is grounded, the MOSFET drivers are disabled. Usually connected to +5V through a pull-up resistor.
23	VID4	Programming Input (MSB)
24	VID3	Programming Input
25	VID2	Programming Input
26	VID1	Programming Input
27	VID0	Programming Input (LSB)
28	PWRGD	Power Good. This open collector logic output is high if the output voltage is within 5-10% of the set point.

5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

N1155

OUTPUT VOLTAGE

 $<\!\!\text{Unless specified: V}_{\text{CC}} = 4.75\text{V} \sim 5.25\text{V}, \\ \text{GND} = \text{PGND} = 0\text{V}, \\ \text{VOSENSE} = \text{V}_{\text{O}}, \\ \text{0mV} < (\text{CS}^+ - \text{CS}^-) < 60\text{mV}, \\ \text{LDOV} = 11.4\text{V} \sim 12.6\text{V}, \\ \text{T}_{\text{A}} = 25^{\circ}\text{C} > 12.6\text{V}, \\ \text{CS}^+ = 1$

- Table 1 -

VID4	VID3	VID2	VID1	VID0	VDC(V)
1	1	1	1	1	Output Off
1	1	1	1	0	1.1
1	1	1	0	1	1.125
1	1	1	0	0	1.15
1	1	0	1	1	1.175
1	1	0	1	0	1.2
1	1	0	0	1	1.225
1	1	0	0	0	1.25
1	0	1	1	1	1.275
1	0	1	1	0	1.3
1	0	1	0	1	1.325
1	0	1	0	0	1.35
1	0	0	1	1	1.375
1	0	0	1	0	1.4
1	0	0	0	1	1.425
1	0	0	0	0	1.45
0	1	1	1	1	1.475
0	1	1	1	0	1.5
0	1	1	0	1	1.525
0	1	1	0	0	1.55
0	1	0	1	1	1.575
0	1	0	1	0	1.6
0	1	0	0	1	1.625
0	1	0	0	0	1.65
0	0	1	1	1	1.675
0	0	1	1	0	1.7
0	0	1	0	1	1.725
0	0	1	0	0	1.75
0	0	0	1	1	1.775
0	0	0	1	0	1.8
0	0	0	0	1	1.825
0	0	0	0	0	1.85

N1155

APPLICATIONS INFORMATION – FUNCTIONAL DESCRIPTION

Reference / Voltage Identification

The reference / voltage identification (VID) section consists of a temperature compensates bandgap reference and a 5-bit voltage selection network. The 5 VID pins are TTL compatible inputs to the VID selection network. They are internally pulled up to +5V generated from the +12V supply by a resistor divider, and provide programmability of output voltage from 1.1V to 1.85V in 23mV increments. Refer to the Output Voltage Table for the VID code settings. The output voltage of the VID network, VREF is within 1% of the normal setting over the full input and output voltage range and junction temperature range. The output of the reference / VID network is indirectly brought out through a buffer to the REFB pin. The voltage on this pin will be within 3mVof VREF. It is not recommended to drive loads with REFB other than setting the hysteresis of the hysteretic comparator, because the current drawn from REFB sets the charging current for the soft start capacitor. Refer to the soft start section for additional information.

Hysteretic Comparator

The hysteretic comparator regulates the output voltage of the synchronous-buck converter. The hysteresis is set by connecting the center point of a resistor divider from REFB to AGND to the HYST pin. The hysteresis of the comparator will be equal to twice the voltage difference between REFB and HYST, and has a maximum value of 60mV. The maximum propagation delay from the comparator inputs to the driver outputs is 250ns.

Low Side Driver

The low side driver is designed to drive a low R_{DS(ON)} N-channel MOSFET, and is rated for 2 amps source and sink. The bias for low side driver is provided internally from V_{DRV}.

High Side Driver

The high side driver is designed to drive a low R_{DS(ON)} N-channel MOSFET, and is rated for 2 amps source

and sink. It can be configured either as a ground referenced driver or as a floating bootstrap driver. When configured as a floating driver, the bias voltage to the driver is developed from the DRV regulator. The internal bootstrap diode, connected between the DRV and BOOT pins, is a schottky for improved drive efficiency. The maximum voltage that can be applied between the BOOT pin and ground is 25V. The driver can be referenced to ground by connecting BOOTLO to PGND, and connecting +12V to the BOOT pin.

Deadtime Control

Deadtime control prevents shoot-through current from flowing through the main power FETs during switching transistor by actively controlling the turn-on times of the FET drivers. The high side driver is not allowed to turn on until the gate drive voltage to the low-side FET is below 2 volts, and the low side driver is not allowed to turn on until the voltage at the junction of the 2 FETs (VPHASE) is below 2 volts. An internal low-pass filter with an 11MHz pole is located between the output of the low-side driver (DL) and the input of the deadtime circuit that controls the high-side driver, to filter out noise that could appear on DL when the high-side driver turns on.

Current Sensing

Current sensing is achieved by sampling and holding the voltage across the high side FET while it is turned on. The sampling network consists of switch and an external 0.1uF an internal 50 hold capacitor. Internal logic controls the turn-on and turn-off of the sample/hold switch such that the switch does not turn on until VPHASE transitions high and turns off when the input to the high side driver goes low. Thus sampling will occur only when the high side FET is conducting current. The voltage at the IO pin equals 2 times the sensed voltage. In applications where a higher accuracy in current sensing is required, a sense resistor can be placed in series with the high side FET and the voltage across the sense resistor can be sampled by the current sensing circuit.

5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

N1155

Droop Compensation

The droop compensation network reduces the load transient overshoot/undershoot at VOUT, relative to VREF. VOUT is programmed to a voltage greater than VREF equal to VREF. (1+R8/R9)(see Typical Application Circuit Page 1) by an external resistor divider from VOUT to the VENSE pin to reduce the undershoot on VOUT during a low to high load current transient. The overshoot during a high to low load current transient is reduced by subtracting the voltage that is on the DROOP pin from VREF. The voltage on the IO pin is divided down with an external resistor divider, and connected to the DROOP pin. Thus, under loaded condition, VOUT is regulated to:

VOUT = VREF . (1+R8/R9) - IOUT . R3/(R1+R3).

Inhibit

The inhibit pin is a TTL compatible digital pin that is used to enable the controller. When INH is low, the output drivers are low, the soft start capacitor is discharged, the soft start current source is disabled, and the controller is in a low \(\beta\) state. When INH goes high, the short across the soft start capacitor is removed, the soft start current source is enabled, and normal converter operation begins. When the system logic supply is connected to INH, it controls power sequencing by locking out controller operation until the system logic supply exceeds the input threshold voltage of the INH circuit; thus the +12V supply and the system logic supply (either +5V or 3.3V) must be above UVLO thresholds before the controller is allowed to start up.

VIN

The VIN undervoltage lockout circuit disables the controller while the +12V supply is below the 10V start threshold during power-up. While the controller is disabled, the output drivers will be low, the soft start capacitor will be shorted and the soft start current is disabled and the controller will be in a low lo state. When VIN exceeds the start threshold, the short across the soft start capacitor is removed, the soft start current source is enabled and normal converter operation begins. There is a 2V hysteresis in the undervoltage lockout circuit for noise immunity.

Soft Start

The soft start circuit controls the rate at which VOUT powers up. A capacitor is connected between SS and AGND and is charged by an internal current source. The value of the current source is proportional to the reference voltage so the charging rate of Css is also proportional to the reference voltage. By making the charging current proportional to VREF, the power-up time for VOUT will be independent of VREF. Thus, Css can remain the same value for all VID settings. The soft start charging current is determined by the following equation: bs = IREFB/5. Where IREFB is the current flowing out of the REFB pin. It is recommended that no additional loads be connected to REFB, other than the resistor divider for setting the hysteresis voltage. Thus these resistor values will determine the soft start charging current. The maximum current that can be sourced by REFB is 500uA.

Power Good

The power good circuit monitors for an undervoltage condition on VOUT. If VSENSE is 7% (nominal) below VREF, then the power good pin is pulled low. The PWRGD pin is an open drain output.

Overvoltage Protection

The overvoltage protection circuit monitors VOUT for an overvoltage condition. If VSENSE is greater than 2.15V(nominal), a fault latch is set and both output drivers are turned off. The latch will remain set until VIN goes below the undervoltage lockout value. A 1ms deglitch timer is included for noise immunity.

5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

N1155

Overcurrent Protection

The overcurrent protection circuit monitors the current through the high side FET. The overcurent threshold is adjustable with an external resistor divider between IO and AGND, with the divider voltage connected to the OCP pin. If the voltage on the OCP pin exceeds 100mV, then a fault latch is set and the output drivers are turned off. The latch will remain set until VIN goes below the undervoltage lockout value. A 1ms deglitch timer is include for noise immunity. The OCP circuit is also designed to protect the high side FET against a short-to-ground fault on the terminal common to both power FETs(VPHASE).

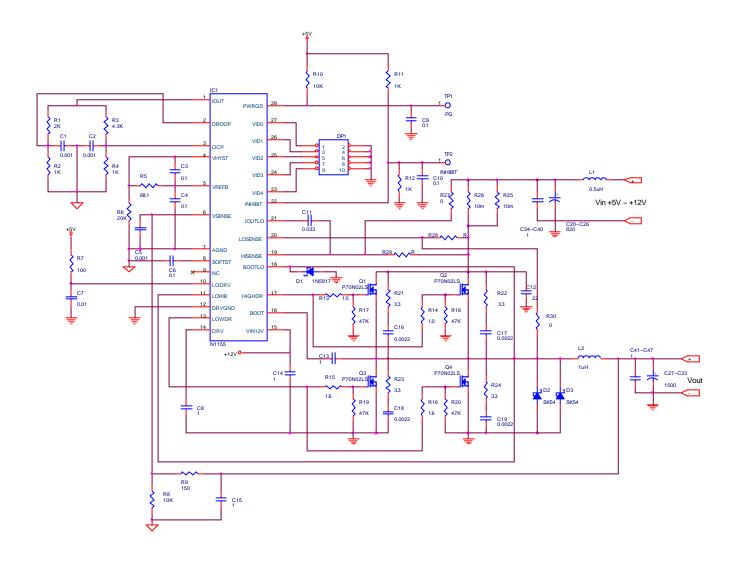
Drive Regulator

The drive regulator provides drive voltage to the low side driver, and to the high side driver when the high side driver is configured as a floating driver. The minimum driver is 7V. The minimum short circuit current is 100mA.

Layout Guidelines (See Page 1)

- 1. Locate R9 and C5 close to pin6 and 7.
- 2. Locate C4 close to pin 5 and 7.
- Components connected to IOUT, DROOP, OCP, VHYST, VREFB, VSENSE, and SOFTST should be referenced to AGND.
- The bypass capacitors C9 and C10 should be placed close to the IC and referenced to DRVGND.
- 5. Locate bootstrap capacitor C13 close to the IC.
- Place bypass capacitor close to Drain of the top FET and Source of the bottom FET to be effective.
- Route HISENSE and LOSENSE close to each other to minimize induced differential mode noise.
- 8. Bypass a high frequency disturbance with ceramic capacitor at the point where HISENSE is connected to Vin.
- Input bulk capacitors should placed as close as possible to the power FETs because of the very high ripple current flow in this pass.
- 10. If schottky diode used in parallel with a synchronous(bottom) FET, to achieve a greater efficiency at lower Vout settings, it needs to be placed next to the aforementioned FET in very close proximity.
- 11. Since the feedback path relies on the accurate sampling of the output ripple voltage, the best results can be achieved by connecting the AGND to the ground side of the bulk output capacitors.
- 12. DRVGND pin should be tight to the main ground plane utilizing very low impedance connection, e.g., multiple vias.
- 13. In order to prevent substrate glitching, a small (0.5A) schottky diode should be placed in close proximity to the chip with the cathode connected to BOOTLO and anode connected to DRVGND.

APPLICATION CIRCUIT

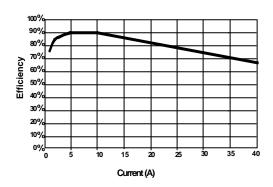


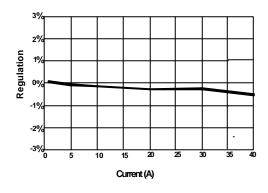
5 Bit Programmable Synchronous DC/DC Hysteretic Controller with VRM 9.0 VID Range

N1155

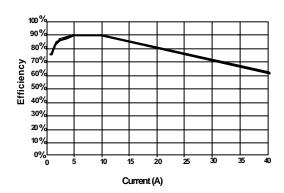
Typical Characteristics

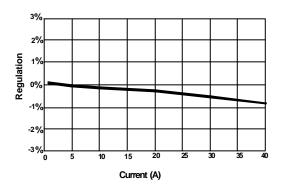
Vin=5V; lout=0A to 40A "Droop"&"Offset" Disabled Vout=1.8V



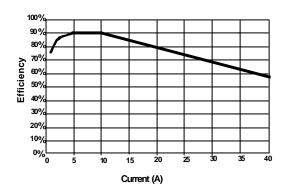


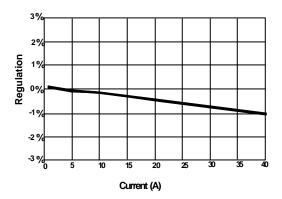
Vout=1.5V



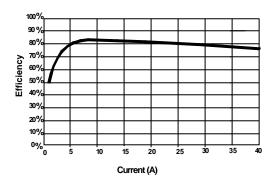


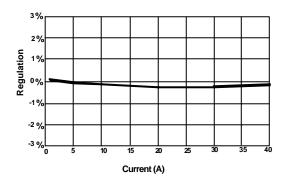
Vout=1.1V



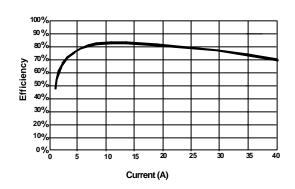


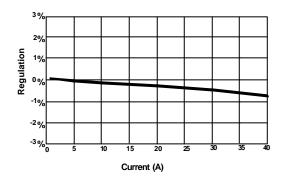
Vin=12V; lout=0A to 40A "Droop" & "Offset" Disabled Vout=1.8V



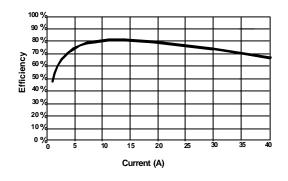


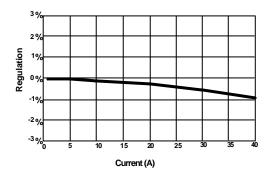
Vout=1.5V





Vout=1.1V





SOIC-28 (DW) MECHANICAL DATA

Dimension	mm			D:	mm			
	Min.	Тур.	Max.	Dimension	Min.	Тур.	Max.	
А	17.7		18.2	Н	0.4		1.27	
В	7.3		7.7	I	0.23		0.32	
С	10		10.65	J	0.25		0.74	
D	0.33		0.51	K	0°		8°	
Е		1.27		L				
F	2.1	2.3	2.5	М				
G	0.1		0.3	N				

